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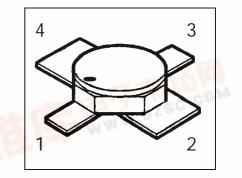


BFY450

HiRel NPN Silicon RF Transistor

- HiRel Discrete and Microwave Semiconductor
- For Medium Power Amplifiers
- Compression Point P-1dB =19dBm 1.8 GHz Max. Available Gain Gma = 16dB at 1.8 GHz
- Hermetically sealed microwave package
- Transition Frequency $f_{T} = 20 \text{ GHz}$
- SIEGET 25-Line Infineon Technologies Grounded Emitter Transistor-25 GHz f_T-Line
- Cesa Space Qualified ESA/SCC Detail Spec. No.: 5611/008 Type Variant No. 03

ESD: Electrostatic discharge sensitive device, observe handling precautions!



Туре	Marking Ordering Code		Pin Configuration				Package
			1	2	3 4	-	TIM
BFY450 (ql)	-	see below	С	Е	В	E	Micro-X

(ql) Quality Level: P: Professional Quality, H: High Rel Quality, S: Space Quality, ES: ESA Space Quality,

Ordering Code:	Q62702F1663
Ordering Code:	on request
Ordering Code:	on request
Ordering Code:	Q62702F1708

(see order instructions for ordering example)





Maximum Ratings

Parameter	Symbol	Values	Unit
Collector-emitter voltage	V _{CEO}	4.5	V
Collector-base voltage	V _{CBO}	15	V
Emitter-base voltage	V _{EBO}	1.5	V
Collector current	I _C	100	mA
Base current	I _B	10	mA
Total power dissipation, $T_S \leq 110^{\circ}C^{-1), 2)}$	P _{tot}	450	mW
Junction temperature	Tj	175	°C
Operating temperature range	T _{op}	-65+175	°C
Storage temperature range	T _{stg}	-65+175	°C
Thermal Resistance		·	
Junction-soldering point ²⁾	R _{th JS}	< 145	K/W

<u>Notes.</u>: 1) At $T_s = +110$ °C. For $T_s > +110$ °C derating is required. 2) T_s is measured on the collector lead at the soldering point to the pcb.

Electrical Characteristics

at $T_A=25^{\circ}C$; unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
$V_{CB} = 5 V, I_{E} = 0$					
Collector-emitter cutoff current ^{1.)}	I _{CEX}	-	-	200	μA
V_{CE} = 4.5 V, I_{B} = 1.0 μA				(t.b.d.)	
Emitter-base cuttoff current	I _{EBO}	-	-	50	μΑ
$V_{EB} = 1.5 V$, $I_{C} = 0$					
DC current gain	h _{FE}	50	90	150	-
I_{C} = 20 mA, V_{CE} = 1 V					

Notes:

1.) This Test assures V(BR)CE0 > 4.5V



Electrical Characteristics (continued)

Parameter	Symbol		Values		Unit
		min.	typ.	max.	
AC Characteristics					
Transition frequency	f⊤				GHz
I_{C} = 90mA, V_{CE} = 3 V, f = 1.0 GHz		18	22	-	
I_{C} = 90mA, V_{CE} = 3 V, f = 2.0 GHz		-	17	-	
Collector-base capacitance	C _{CB}	-	0.42	0.9	pF
V_{CB} = 2 V, V_{BE} = vbe = 0, f = 1 MHz					
Collector-emitter capacitance	C _{CE}	-	1.27	2.6	pF
V_{CE} = 2 V, V_{BE} = vbe = 0, f = 1 MHz					
Emitter-base capacitance	C _{EB}	-	2.0	3	pF
V_{EB} = 0.5V, V_{CB} = vcb = 0, f = 1 MHz					
Noise Figure	F	-	1.25	2.0	dB
I_{C} = 10 mA, V_{CE} = 2 V, f = 1.8 GHz,					
$Z_{S} = Z_{sopt}$					
Insertion power gain	$\left S_{21e}\right ^2$	8.0	12	-	dB
I_{C} = 50 mA, V_{CE} = 2 V, f = 1.8 GHz					
$Z_S = Z_L = 50 \ \Omega$					
Power gain	Gma ^{1.)}	-	16.0	-	dB
I_{C} = 50 mA, V_{CE} = 2 V, f = 1.8 GHz					
$Z_{S} = Z_{Sopt}$, $Z_{L} = Z_{Lopt}$					
1dB Compression point	P _{-1dB}	-	19	-	dBm
I_{C} = 50 mA, V_{CE} = 2 V, f = 1.8 GHz					
$Z_S = Z_{Sopt}$, $Z_L = Z_{Lopt}$					

Notes .:

1)
$$G_{ma} = \left| \frac{S21}{S12} \right| (k - \sqrt{k^2 - 1}), \quad G_{ms} = \left| \frac{S21}{S12} \right|$$



Order Instructions:

Full type variant including quality level must be specified by the orderer. For *HiRel* Discrete and Microwave Semiconductors the ordering code specifies device family and quality level.

Ordering Form:

Ordering Code: Q..... BFY450 (ql) (ql): Quality Level

Ordering Example:

Ordering Code: Q62702F1708 BFY450 ES For BFY450 in ESA Space Quality Level

Further Informations:

See our WWW-Pages:

- Discrete and RF-Semiconductors (Small Signal Semiconductors) <u>www.infineon.com</u>/products/discrete/hirel.htm
- *HiRel* Discrete and Microwave Semiconductors www.infineon.com/products/discrete/hirel.htm

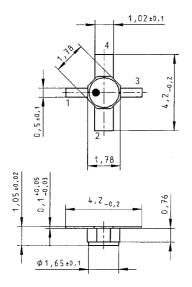
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Micro-X Package



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